



BUS-MI5ML-BC1-RP-L

Micro USB
SMT 5S Type

Housing Material:
L:L:CP

Housing Color:
B:Black

Package Type:
RP:Reel Package
卷装

Contact Plating:
1:1u
3:3u

Shell Material:
C:Brass of Ni Plated 铜壳镀镍

Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f, UL94v-0
- 1.2 Contact: copper alloy, t=0.20mm
- 1.3 Shell: copper alloy, t=0.25mm

2.Specification:

- 2.1 Current rating: 1 A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 50 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.0.81~2.05 Kgf Min.after 10000 insertion/extraction cycles
- 2.7 Temperature range: -30°C~80°C



单位	比例	日期
mm	5:1	2010-08-31

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核准	审核	设计绘图
Jason	Euni	Ada

料号	品名
BUS-MI5ML-BC1-RP-L	Micro USB Connectors

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Micro USB Connectors
BUS-MI5ML-BC1-RP-L

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